As an inventor named below or on any attached continuation page, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name.

is attached hereto.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled METHOD OF DISPOSING CONDUCTIVE BUMPS ONTO A SEMICONDUCTOR DEVICE AND SEMICONDUCTOR DEVICES SO FORMED, the specification of which (check one):

□ was filed on	as United States application s as PCT international applicat		amended on unended under PCT Article 19 on		
I hereby state that I have referred to above.	eviewed and understand the conte	nts of the above-identified spec	cification, including the claims, as amend	led by any amen	dment
	disclose to the U.S. Patent and Tr tion, as "materiality" is defined in		n known to me to be material to the pate gulations § 1.56.	ntability of the si	ubject
certificate or § 365(a) of any attached continuation page an	PCT international application(s) do dhave also identified below and o	esignating at least one country n any attached continuation pa	r § 365(b) of any foreign application(s) for other than the United States of America ge any foreign application for patent or in the foreign application for patent or its famous and the foreign application for patent of America having a filing date before the	listed below and nventor's certific	on any cate or any
Prior foreign/PCT application	n(s):			Priority Claim	ied
(number)		(country)	(day/month/year filed)	Yes	No
(number) I hereby claim the benefit designating the United States		(country)	(day/month/year filed)	Yes	No No
Regulations § 1.56 which bed	ame available between the filing d		naterial to patentability as defined in Titl nd the national or PCT international filin (status - pending, patented o	g date of this ap	
1 11		(filing date)	(status - pending, patented o		
(application serial		e, § 119(e) of any United Stat	es provisional application(s) listed below	:	
I hereby appoint the follotherewith:	ving Registered Practitioners to pr	osecute this application and to	transact all business in the Patent and Tr	rademark Office	connected
David V. Trask, Reg. No Laurence B. Bond, Reg. Allen C. Turner, Reg. No Stephen R. Christian, Reg Paul C. Oestreich, Reg. No Kenneth C. Booth, Reg. I Lia M. Pappas, Reg. No.	No. 30,549 b. 33,041 c. No. 32,687 do. P-44,983 No. 42,342 34,095 Joseph A. W Kent S. Burn Brick G. Po Devin R. Jet Samuel E. V		Thomas J. Rossa, Reg. No. 26, James R. Duzan, Reg. No. 28,3 Edgar R. Cataxinos, Reg. No. 3 Kenneth B. Ludwig, Reg. No. 4 Eleanor V. Goodall, Reg. No. 30 Michael L. Lynch, Reg. No. 30	93 9,931 12,814 15,162	

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

issued dicteon.

Full name of first joint inventor: Michael B. Ball

Citizenship: U.S.A.

Post Office Address: 8630 Pembrook Drive, Boise, ID 83704

Invention title: METHOD OF DISPOSING CONDUCTIVE BUMPS ONTO A SEMICONDUCTOR DEVICE AND SEMICONDUCTOR DEVICES SO **FORMED**

Inventor name(s) appearing on first declaration page: Michael B. Ball

Additional original, first and joint inventor(s):

Full name of second joint inventor: Chad A. Cobbley

Inventor's signature
Residence: Boise, Idaho
Citizenship: U.S.A.

Post Office Address: 608 Boise Hills Drive, Boise, ID 83702





PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Serial No.: Michael B. Ball and Chad A. Cobbley

Examiner: Group Art Unit: Unknown Unknown

Filed:

Not yet assigned Attorney Docket No.:

3817US (97-1350)

Title:

METHOD OF DISPOSING CONDUCTIVE BUMPS ONTO A SEMICONDUCTOR DEVICE AND SEMICONDUCTOR

DEVICES SO FORMED

POWER OF ATTORNEY BY ASSIGNEE AND CERTIFICATE UNDER 37 CFR § 3.73(b)

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

MICRON TECHNOLOGY, INC., assignee of the entire right, title and interest by assignment from the inventor(s) in the aboveidentified application, hereby appoints the following attorneys and agents:

David V. Trask, Reg. No. 22,012 Laurence B. Bond, Reg. No. 30,549 Allen C. Turner, Reg. No. 33,041 Stephen R. Christian, Reg. No. 32,687 Paul C. Oestreich, Reg. No. P-44,983 Kenneth C. Booth, Reg. No. 42,342 Lia M. Pappas, Reg. No. 34,095

William S. Britt, Reg. No. 20,969 Joseph A. Walkowski, Reg. No. 28,765 Kent S. Burningham, Reg. No. 30,453 Brick G. Power, Reg. No. 38,581 Devin R. Jensen, Reg. No. P-44,805 Samuel E. Webb, Reg. No. 44,394

Thomas J. Rossa, Reg. No. 26,799 James R. Duzan, Reg. No. 28,393 Edgar R. Cataxinos, Reg. No. 39,931 Kenneth B. Ludwig, Reg. No. 42,814 Eleanor V. Goodall, Reg. No. 35,162 Michael L. Lynch, Reg. No. 30,871

as its attorneys with full power of substitution to prosecute this application and all applications claiming filing date priority therefrom and to transact all business in the U.S. Patent and Trademark Office in connection therewith.

The above-identified assignee hereby elects, pursuant to 37 C.F.R. § 3.71, to conduct the prosecution of the above-identified patent application to the exclusion of the inventor(s).

A chain of title from the inventor(s) of the above-identified patent application to the above-identified assignee is shown:

- [] In an assignment recorded in the U.S. Patent and Trademark Office at Reel, Frame.
- [] In an assignment filed herewith for recordation, a true copy of which is attached hereto.

The undersigned has reviewed the above-identified assignment and, to the best of his knowledge and belief, title is in the above-identified assignee.

The undersigned further avers that he is empowered to make and sign the foregoing certification on behalf of the above-identified assignee, and to take the action set forth herein on its behalf.

Please direct all communications regarding the above-identified application to:

Brick G. Power, TRASK, BRITT & ROSSA P.O. Box 2550 Salt Lake City, UT 84110 Tele: (801) 532-1922

Fax: (801) 531-9168

Respectfully Submitted,

MICRON TECHNOLOGY, INC.

Date: 4725,1999

Michael L. Lynch, Esq. Reg. No. 30,871

Chief Patent Counsel, MICRON TECHNOLOGY, INC.

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